

### 1.6X0.8mm SMD CHIP LED LAMP

Part Number: APT1608SURCK-AMT

Hyper Red

## **Features**

- High reliability LED package.
- 1.6mmx0.8mm SMT LED,0.75mm thickness
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

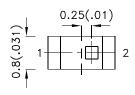
## **Description**

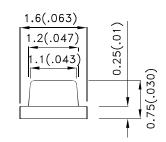
The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

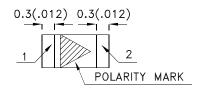
## **Applications**

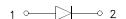
- Traffic signaling.
- Backlighting (illuminated advertising, general lighting).
- Interior and exterior automotive lighting.
- Substitution of micro incandescent lamps.
- · Reading lamps.
- Signal and symbol luminaire for orientation.
- Marker lights (e.g. Steps, exit ways, etc).
- Decorative and entertainment lighting.
- Indoor and outdoor commercial and residential architectural lighting.

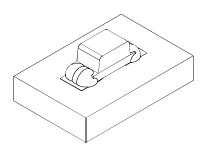
## **Package Dimensions**











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA			Viewing Angle [1]
			Code.	Min.	Max.	201/2
APT1608SURCK-AMT	Hyper Red (AlGaInP)	Water Clear	N	120	200	120°
			Р	200	300	
			Q	300	400	

- Notes: 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit	
Power dissipation	PD	75	mW	
Reverse Voltage	VR	5	V	
Junction temperature	TJ	120	°C	
Operating Temperature	Тор	-40 To +100	°C	
Storage Temperature	Tstg	-40 To +120	°C	
DC Forward Current[1]	lF	30	mA	
Peak Forward Current [2]	lғм	185	mA	
Electrostatic Discharge Threshold (HBM)	3000	V		
Thermal Resistance (Junction/ambient) [1]	Rth j-a	350	°C/W	

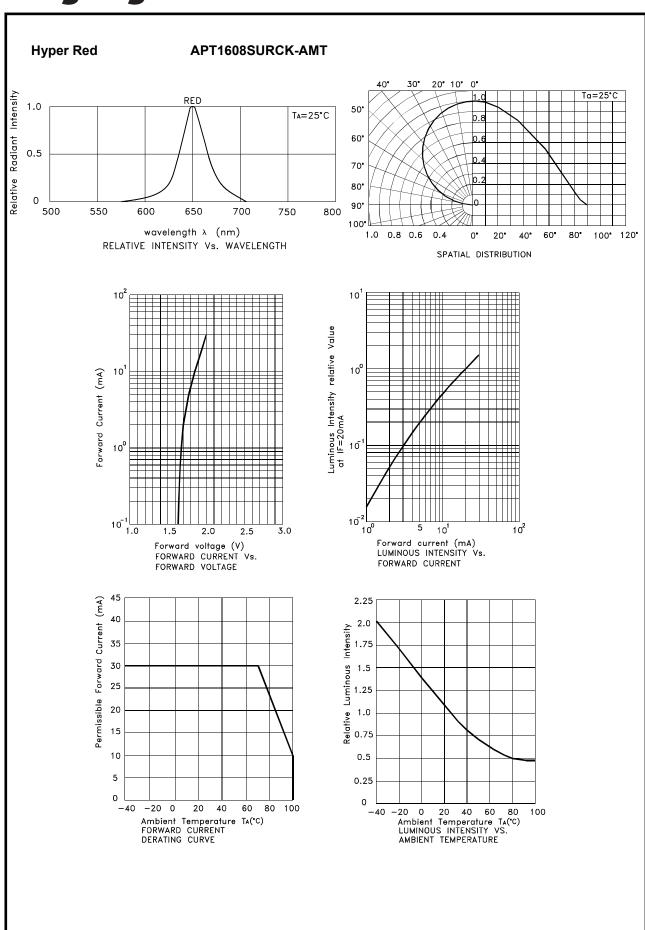
- 1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),
- 2. 1/10 Duty Cycle, 0.1ms Pulse Width.

## Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Value	Unit	
Wavelength at peak emission IF=20mA [Typ.]	λ peak	650	nm	
Dominant Wavelength IF=20mA [Min.]	λ dom [1]	620	nm	
Dominant Wavelength IF=20mA [Max.]	λ dom [1]	640	nm	
Spectral bandwidth at 50%Φ REL MAX IF=20mA [Typ.]	Δλ	28	nm	
Forward Voltage IF=20mA [Min.]	VF [2]	-		
Forward Voltage IF=20mA [Typ.]		1.95	V	
Forward Voltage IF=20mA [Max.]		2.5		
Reverse Current (VR = 5V) [Max.]	lr	10	uA	
Temperature coefficient of $\lambda$ peak IF=20mA, -10 $^{\circ}$ C $\leq$ T $\leq$ 100 $^{\circ}$ C [Typ.]	TC λ peak	0.14	nm/° C	
Temperature coefficient of $\lambda$ dom IF=20mA, -10 $^{\circ}$ C $\leq$ T $\leq$ 100 $^{\circ}$ C [Typ.]	TC λ dom	0.05	nm/° C	
Temperature coefficient of VF IF=20mA, -10 $^{\circ}$ C $\leq$ T $\leq$ 100 $^{\circ}$ C [Typ.]	TCv	-1.8	mV/° C	

- 1. The dominant Wavelength ( $\lambda$  d) above is the setup value of the sorting machine. (Tolerance  $\lambda$  d:  $\pm 1$ nm.)
- 2. Forward Voltage: +/-0.1V.

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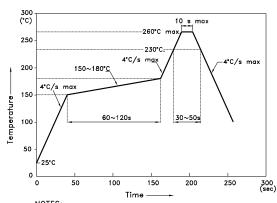


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### **APT1608SURCK-AMT**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

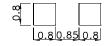


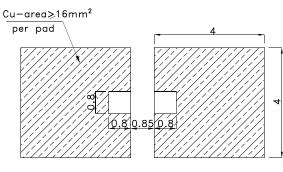
1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3. Number of reflow process shall be 2 times or less.

## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Pad design for improved heat dissipation

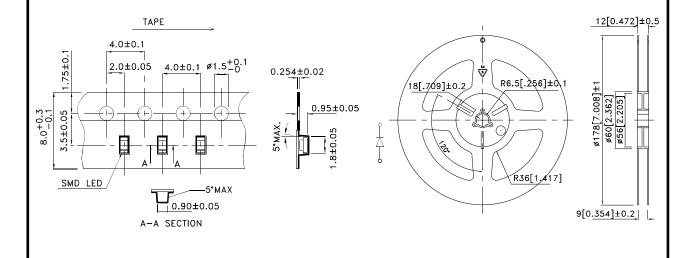




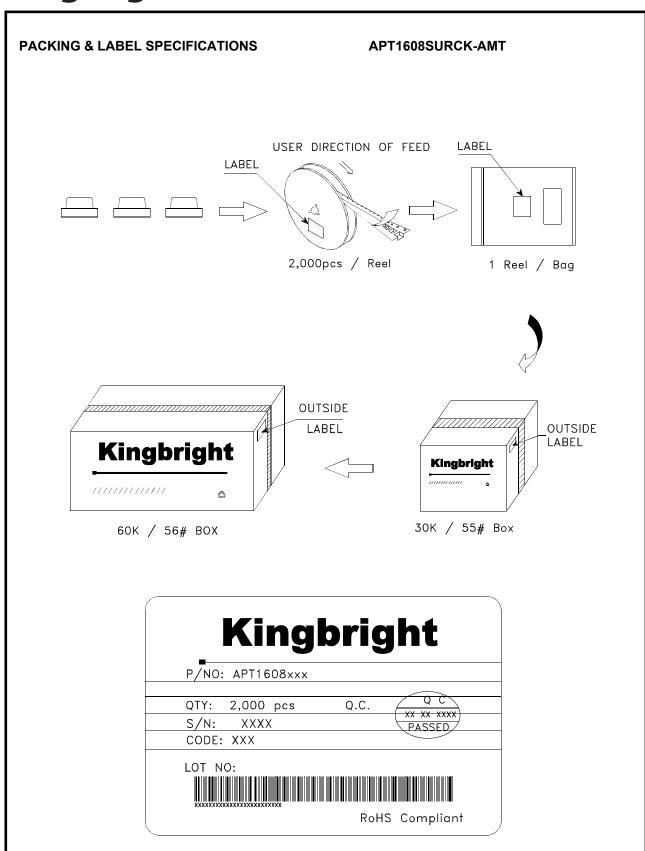
Solder resist

## Tape Specifications (Units: mm)

## **Reel Dimension**



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## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	Ta =25°C ,IF = maximum rated current*	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED- 4701/100(101)	Ta = 100°C IF = maximum rated current*	1,000 h	0 / 22
3	Low Temp. operating test	-	Ta = -40°C, IF = maximum rated current*	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED- 4701/100(201)	Ta = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED- 4701/100(202)	Ta = -40°C	1,000 h	0 / 22
6	IHIAN TAMP X. NIIMIAITY STATEMENT TAST	EIAJ ED- 4701/100(103)	Ta = 60°C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED- 4701/100(102)	Ta = 60°C, RH = 90% IF = maximum rated current*	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED- 4701/100(301)	Moisture soak : 30°C,70% RH, 72h Preheat : 150~180°C(120s max.) Soldering temp : 260°C(10s)	3 times	0 / 18
9	Thermal shock operating test	-	Ta = -40°C(15min) ~ 100°C(15min) IF = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	Ta = -40°C(15min) ~ maximum rated storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED- 4701/100(304)	C = 100pF , R2 = 1.5KΩ V = 3000V	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s², f = 100~2KHz, t = 48min for all xyz axes	4 times	0 / 22

<sup>\* :</sup> Refer to forward current vs. derating curve diagram

## **Failure Criteria**

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	IF = 20mA	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	IF = 20mA	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	lR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	l -	Occurrence of notable decoloration, deformation and cracking

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